AEC-Q101 Qualified

General purpose (dual transistors)

IMT4FRA

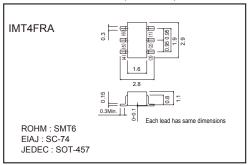
● Features

- 1) Two 2SA1514KFRA chips in an AMT package.
- 2) High breakdown voltage.

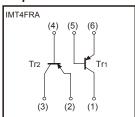
● Package, marking, and Packaging specifications

Part No.	IMT4FRA
Package	SMT6
Marking	T4
Code	T108
Basic ordering unit (pieces)	3000

●External dimensions (Unit : mm)



Equivalent circuit



● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol Limits		Unit	
Collector-base voltage	Vcвo	-120	V	
Collector-emitter voltage	Vceo	-120	V	
Emitter-base voltage	VEBO	-5	V	
Collector current	Ic	-50	mA	
Power dissipation	Pc	300 (TOTAL)	mW *	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

^{*200}mW per element must not be exceeded.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	ВУсво	-120	-	_	V	Ic=-50μA
Collector-emitter breakdown voltage	BVceo	-120	-	_	V	Ic=-1mA
Emitter-base breakdown voltage	BVEBO	-5	-	_	V	I _E =-50μA
Collector cutoff current	Ісво	-	-	-0.5	μΑ	VcB=-100V
Emitter cutoff current	ІЕВО	-	-	-0.5	μА	V _{EB} =-4V
DC current transfer ratio	hfe	180	-	820	-	Vc=-6V, Ic-2mA
Transition frequency	f⊤	-	140	_	MHz	Vc=-12V, Ie=2mA, f=100MHz *
Collector-emitter saturation voltage	V _{CE(sat)}	-	-	-0.5	V	Ic/I _B =-10mA/-1mA

^{*}Transition frequency of the device.

Electrical characteristic curves

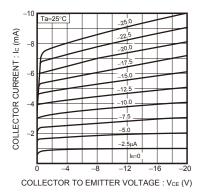


Fig.1 Ground emitter output characteristics

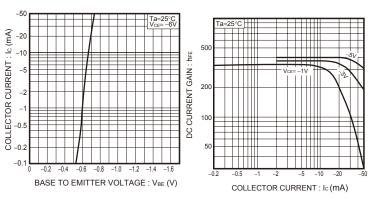


Fig.2 Ground emitter propagation characteristics

Fig.3 DC current gain vs. collector current

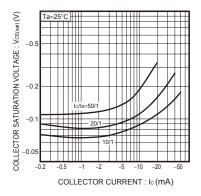


Fig.4 Collector-Emitter saturation voltage vs. collector current

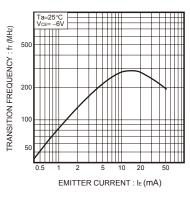


Fig.5 Transition frequency vs. emitter current

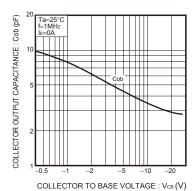


Fig.6 Collector output capacitance vs. collector-base voltage

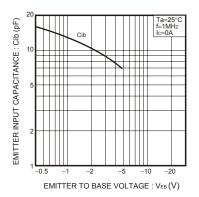


Fig.7 Emitter input capacitance vs. emitter-base voltage

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

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 - [d] the Products are exposed to high Electrostatic
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- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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